



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

PATENT

IN RE APPLICATION OF: WHONCHEE LEE ET AL.

APPLICATION No.: 09/888,084

FILED: JUNE 21, 2001

FOR: **METHODS AND APPARATUS FOR
ELECTRICAL, MECHANICAL AND/OR
CHEMICAL REMOVAL OF
CONDUCTIVE MATERIAL FROM A
MICROELECTRONIC SUBSTRATE**

EXAMINER: DUNG V. NGUYEN

ART UNIT: 3723

CONF. NO: 8101

RECEIVED
SEP 17 2003

Amendment Under 37 C.F.R. § 1.111 TECHNOLOGY CENTER R3700

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

The present communication responds to the Office Action dated June 13, 2003 in the above-identified application. Please amend the application as follows:

Amendments to the Claims are reflected in the listing of claims beginning on page 2.

09/16/2003 BSAYASI1 00000134 09888084

01 FC:1201 252.00 OP

10/09/2003 NCHAPMAN 00000002 500665 09888084

01 FC:1202 90.00 DA
02 FC:1201 168.00 DA